

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	3026445
<b>Application Number:</b>	10762901
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	6163
<b>Title of Invention:</b>	Microparticle loaded solder preform allowing bond site control of device spacing at micron, submicron, and nanostructure scale
<b>First Named Inventor/Applicant Name:</b>	Joseph L. Pikulski
<b>Customer Number:</b>	31714
<b>Filer:</b>	Christopher Roger Balzan
<b>Filer Authorized By:</b>	
<b>Attorney Docket Number:</b>	HRL/007-03
<b>Receipt Date:</b>	19-MAR-2008
<b>Filing Date:</b>	22-JAN-2004
<b>Time Stamp:</b>	23:59:10
<b>Application Type:</b>	Utility under 35 USC 111(a)

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Request for Continued Examination (RCE)	PTO_RCE_HRL_007-03.pdf	124346 5f06775f71107fd0226a040dedc287031c2aa16f	no	1

### Warnings:

This is not a USPTO supplied RCE SB30 form.

**Information:**

2	Amendment After Final	PTO_Response_FOA.pdf	102365	no	11
			26dd9db5a641c619980c6c602301bd430fbfb34		

**Warnings:**

**Information:**

3	Information Disclosure Statement (IDS) Filed	PTO_IDS02_HRL_007-03.pdf	99734	no	1
			0cf7378fe5b2cbb5ecc002fc6892124aef0b1e6		

**Warnings:**

**Information:**

This is not an USPTO supplied IDS fillable form

4	Foreign Reference	EP0795891A2_translated.pdf	1164438	no	18
			882a0d9d3873d3b66047986386abc6bffe0485d9		

**Warnings:**

**Information:**

<b>Total Files Size (in bytes):</b>	1490883
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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.